

The TBK5 is a high voltage, high current disc pack SCR employing distributed gate structure. This design allows the SCR to be reliably operated at high di/dt and dv/dt conditions in various phase control applications.

FEATURES:

- Low On-State Voltage
- High di/dt Capability
- High dv/dt Capability
- Hermetic Ceramic Package
- Excellent Surge and I^2t Ratings

APPLICATIONS:

- DC Power Supplies
- Motor Controls

ORDERING INFORMATION

Select the complete 12 digit Part Number using the table below.
 EXAMPLE: TBK5163203DH is a 1600V-3200A SCR with 200ma IGT and 12 inch gate and cathode potential leads.

PART	Voltage Rating $V_{DRM}-V_{RRM}$	Voltage Code	Current Rating I_{TAVG}	Current Code	Turn-Off t_q	Gate I_{GT}	Leads
TBK5	800	08	3200	32	0	3	
	1000	10					
	1200	12			400us	200ma	12"
	1400	14			(typ.)	(max)	
	1600	16					

Revised: 9/29/2008

Absolute Maximum Ratings

Characteristic	Symbol	Rating	Units
Repetitive Peak Voltage	$V_{DRM}-V_{RRM}$	1600	Volts
Average On-State Current, $T_C=74^{\circ}C$	$I_{T(Avg.)}$	3200	A
RMS On-State Current, $T_C=74^{\circ}C$	$I_{T(RMS)}$	5027	A
Average On-State Current, $T_C=50^{\circ}C$	$I_{T(Avg.)}$	4100	A
RMS On-State Current, $T_C=50^{\circ}C$	$I_{T(RMS)}$	6440	A
Peak One Cycle Surge Current, 60Hz, $V_R=0V$	I_{TSM}	62,000	A
Peak One Cycle Surge Current, 50Hz, $V_R=0V$	I_{TSM}	58,454	A
Fuse Coordination I^2t , 60Hz	I^2t	1.60E+07	A^2s
Fuse Coordination I^2t , 50Hz	I^2t	1.71E+07	A^2s
Critical Rate-of-Rise of On-State Current Repetitive $.67 \cdot V_{DRM}$	di/dt	100	A/us
Critical Rate-of-Rise of On-State Current Non-Repetitive $.67 \cdot V_{DRM}$	di/dt	200	A/us
Peak Gate Power, 100us	P_{GM}	16	Watts
Average Gate Power	$P_{G(avg)}$	5	Watts
Operating Temperature	T_j	-40 to+125	$^{\circ}C$
Storage Temperature	$T_{Stg.}$	-50 to+150	$^{\circ}C$
Approximate Weight		3.5	lb
		1.59	Kg
Mounting Force		9000-10000	lbs
		40 - 44.5	KNewtons

Information presented is based upon manufacturers testing and projected capabilities. This information is subject to change without notice. The manufacturer makes no claim as to suitability for use, reliability, capability or future availability of this product.

Electrical Characteristics, T_j=25°C unless otherwise specified

Characteristic	Symbol	Test Conditions	Rating			Units
			min	typ	max	
Repetitive Peak Forward Leakage Current	I _{DRM}	T _j =125°C, V _{DRM} =Rated			150	ma
Repetitive Peak Reverse Leakage Current	I _{RRM}	T _j =125°C, V _{RRM} =Rated			150	ma
Peak On-State Voltage	V _{TM}	T _j =125°C, I _{TM} =2000A			1.05	V
V _{TM} Model, Low Level	V ₀	T _j =125°C			0.826	V
V _{TM} = V ₀ + r•I _{TM}	r	15% I _{TM} - π•I _{TM}			1.07E-01	mΩ
V _{TM} Model, High Level	V ₀	T _j =125°C			1.095	V
V _{TM} = V ₀ + r•I _{TM}	r	π•I _{TM} - I _{TSM}			7.99E-02	mΩ
V _{TM} Model, 4-Term	A	T _j =125°C			0.784	
V _{TM} = A + B•Ln(I _{TM}) +	B	15% I _{TM} - I _{TSM}			-0.016	
C•(I _{TM}) + D•(I _{TM}) ^{1/2}	C				0.000063	
	D				0.00584	
Turn-On Delay Time	t _d	V _D = 0.5•V _{DRM} Gate Drive: 40V - 20Ω			3.5	us
Turn-Off Time	t _q	T _j =125°C dv/dt = 20V/us to 80% V _{DRM}			400	us
Reverse Recovery Current	I _{R(Rec)}	T _j =125°C 1500A -10A/us				A
Reverse Recovery Charge	Q _{RR}					uCoul
dv/dt _(Crit)	dv/dt	T _j =125°C Exp. Waveform V _D =80% Rated	1000			V/us
Gate Trigger Current	I _{GT}	T _j =25°C V _D = 12V	30	100	200	ma
Gate Trigger Voltage	V _{GT}		0.8	2.0	3.0	V
Peak Reverse Gate Voltage	V _{GRM}				5	V

Thermal Characteristics

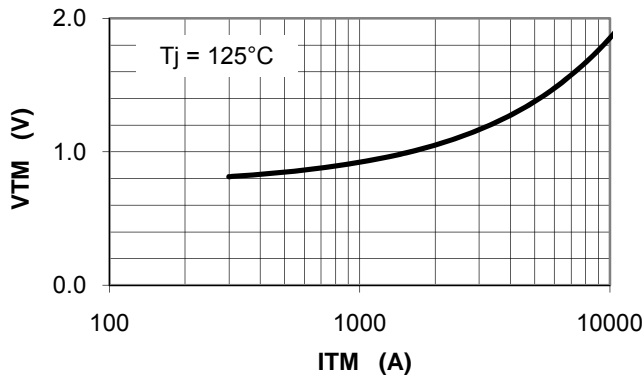
Characteristic	Symbol	Test Conditions	Rating			Units
			min	typ	max	
Thermal Resistance						
Junction to Case	Rθ _{jc}	Double side cooled		0.009	0.010	°C/Watt
Case to Sink	Rθ _{cs}	Double side cooled		0.0016	0.002	°C/Watt

 Thermal Impedance Model Zθ_{jc} Double side cooled

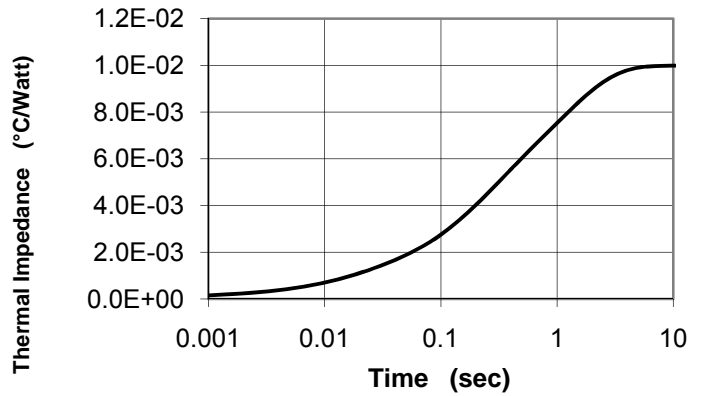
$$Z\theta_{jc}(t) = \sum(A(N) \cdot (1 - \exp(-t/\text{Tau}(N))))$$

where:	N =	1	2	3	4
	A(N) =	1.10E-04	8.86E-04	4.54E-03	4.50E-03
	Tau(N) =	5.05E-04	1.33E-02	2.46E-01	1.85E+00

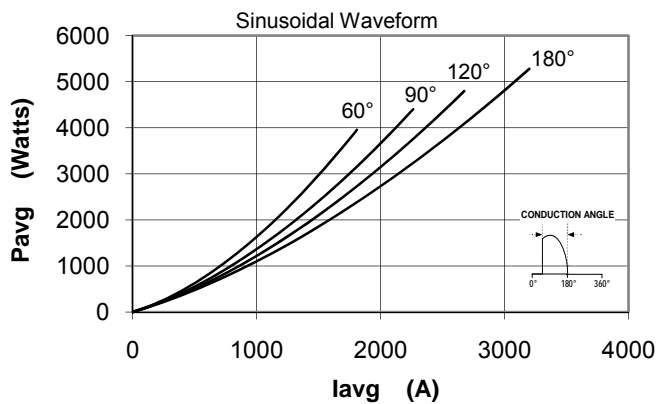
Maximum On-State Voltage Drop



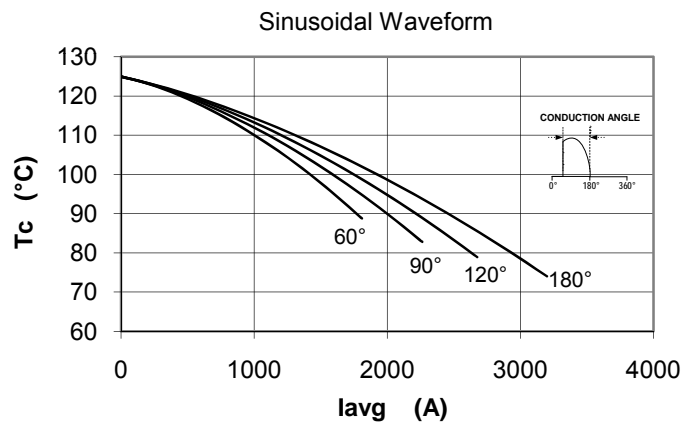
MAXIMUM TRANSIENT THERMAL IMPEDANCE



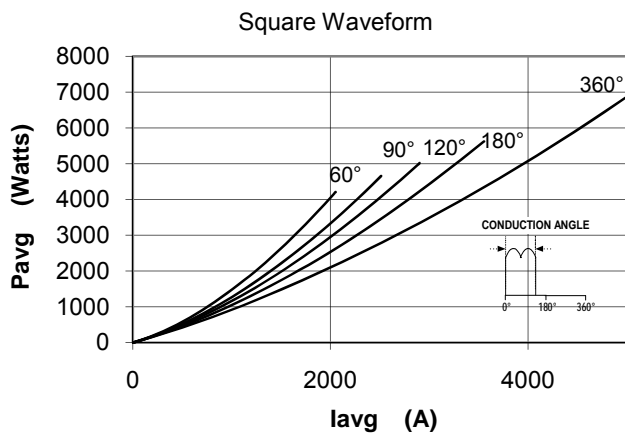
Maximum On-State Power Dissipation



Maximum Allowable Case Temperature



Maximum On-State Power Dissipation



Maximum Allowable Case Temperature

